CMOS LSI

SANYO

No.1802C

LC6514B

SINGLE-CHIP 4-BIT MICROCOMPUTER
(LOW-THRESHOLD INPUT,
ON-CHIP FLT DRIVER)

The LC6514B is a microcomputer with FLT drivers.   It is identical with the LC6510C in the internal architecture and instruction set. Since the normal/low-threshold level of input port A can be selected by option and the on-chip pull-down resistor can be bitwise connected to the FLT driver by option, the number of external parts used in the user equipment can be minimized, reducing the cost considerably.

(Note) The LC6514B heretofore in use has been improved by changing the value of the pull-down resistor to be contained in FLT drivers as shown below. When using the LC6514B, fully check that the new resistor value meets your application specifications.

|		New resistor value			Old resistor value			
		min	typ	max	min	typ	max	
"L"-level output current	I_{OL}	0.190	0.362	0.760	0.108	0.304	0.543	mA
(Output pull-down resistance)	(R_{PD})	(200)	(105)	(50)	(350)	(125)	(70)	(kΩ)

Features

- Low power dissipation
- ROM capacity: 4096 x 8 bits
- RAM capacity: 256 x 4 bits
- Subroutine stack: 8 levels (common with interrupt)
- On-chip OSC circuit
  CR OSC: 800kHz typ.
  Ceramic OSC: 400kHz, 800kHz, 1000kHz
  External input: 1290kHz max.
- Power-down by 2 standby modes
  HALT mode: Power dissipation saving by program standby during normal operation
  HOLD mode: Power supply backup during power failure
- Input/output ports
  Input: 4 bits x 1 port
                  3 bits x 1 port
  Input/output: 4 bits x 2 ports
  Output: 4 bits x 4 ports
                  2 bits x 1 port
- Interrupt
  External interrupt: 1
  Internal timer interrupt: 1
- On-chip 4-bit prescaler and 8-bit program timer
- Instruction cycle time: 3.1μs   (at 1290kHz)
- Supply voltage
  Normal operation: 4.0 to 6.0V
  Memory hold: 1.8 to 6.0V
- Instruction set common to the LC6502, LC6505 (BANK instruction added)
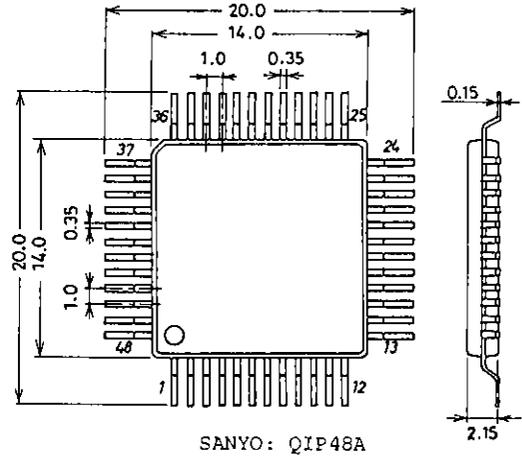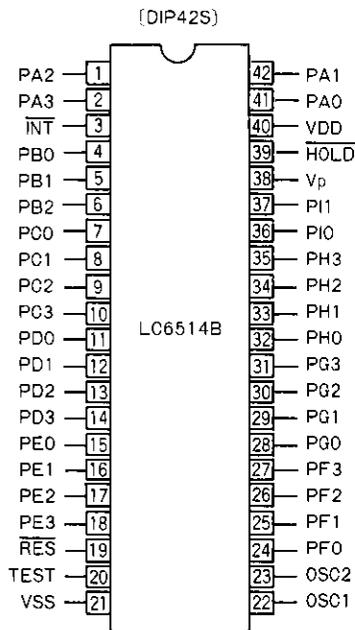
• Package: DIP42S (shrink)
  QIP48

Package Dimensions 3025B-D42SIC
(unit: mm)

SANYO: DIP42S
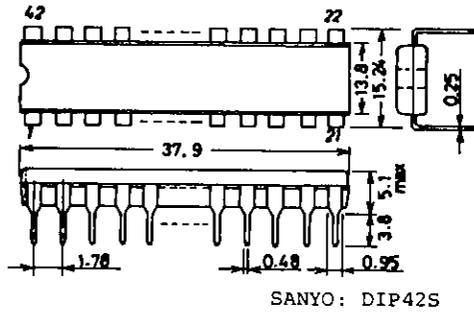
Package Dimensions 3052A-Q48AIC
(unit: mm)

SANYO: QIP48A

Pin Assignment

[DIP42S]

Pin Name

Pin	Description
OSC1, OSC2:	C, R or ceramic resonator for system OSC
$\overline{INT}$:	Interrupt
$\overline{RES}$:	Reset
$\overline{HOLD}$:	Hold
PA$_{0 \text{ to } 3}$:	Input port A$_{0 \text{ to } 3}$
PB$_{0 \text{ to } 2}$:	Input port B$_{0 \text{ to } 2}$
PC$_{0 \text{ to } 3}$:	Input/output common port C$_{0 \text{ to } 3}$
PD$_{0 \text{ to } 3}$:	Input/output common port D$_{0 \text{ to } 3}$
PE$_{0 \text{ to } 3}$:	Output port E$_{0 \text{ to } 3}$
PF$_{0 \text{ to } 3}$:	Output port F$_{0 \text{ to } 3}$
PG$_{0 \text{ to } 3}$:	Output port G$_{0 \text{ to } 3}$
PH$_{0 \text{ to } 3}$:	Output port H$_{0 \text{ to } 3}$
PI$_{0, 1}$:	Output port I$_{0, 1}$
TEST:	Test
Vp:	Power supply for high-voltage port pull-down resistor

With High-voltage driver

[QIP48]
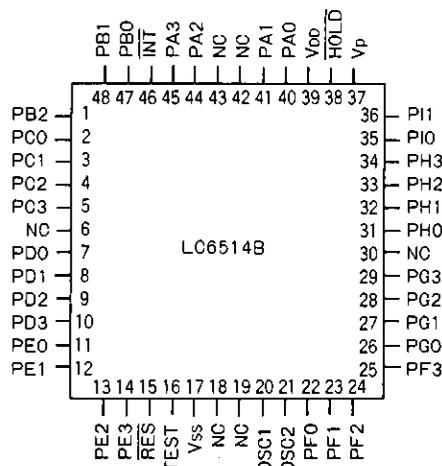
When mounting the QIP package version on the board, do not dip it in solder.

NC pin: No connection

LC6514B

Pin Description

Pin Name	Input/Output	Function
$\overline{INT}$	Input	Interrupt request input pin.
$\overline{HOLD}$	Input	HOLD mode request input pin (Differs from the LC6502/05 in function.) Capable of being used as a general-purpose single-bit input port unless the standby mode is used.
$\overline{RES}$	Input	Reset input pin.
PA$_0$ to 3	Input	Input port A$_0$ to A$_3$ (Normal voltage). Capable of 4-bit input and single-bit decision for branch. Used also for HALT mode release request input. Low threshold input for 4 bits selectable by option.
PB$_0$ to 2	Input	Input port B$_0$ to B$_2$ (Normal voltage) Capable of 3-bit input and single-bit decision for branch.
PC$_0$ to 3	Input/output	Input/output common port C$_0$ to C$_3$ (Normal voltage). Capable of 4-bit input and single-bit decision for branch during input. Capable of 4-bit output and single-bit set/reset during output.
PD$_0$ to 3	Input/output	Input/output common port D$_0$ to D$_3$ (Normal voltage). Capable of 4-bit input and single-bit decision for branch during input. Capable of 4-bit output and single-bit set/reset during output.
PE$_0$ to 3	Output	Output port E$_0$ to E$_3$ (with high-voltage segment driver). Capable of 4-bit output and single-bit set/reset. Capable of 4-bit input of output latch contents and single-bit decision of output latch for branch. Use/nonuse of pull-down resistor bitwise selectable by option.
PF$_0$ to 3	Output	Output port F$_0$ to F$_3$ (with high-voltage segment driver). Capable of 4-bit output and single-bit set/reset. Capable of 4-bit input of output latch contents and single-bit decision of output latch for branch. Use/nonuse of pull-down resistor bitwise selectable by option.
PG$_0$ to 3	Output	Output port G$_0$ to G$_3$ (with high-voltage digit driver). Capable of 4-bit output and single-bit set/reset. Capable of 4-bit input of output latch contents and single-bit decision of output latch for branch. Use/nonuse of pull-down resistor bitwise selectable by option.
PH$_0$ to 3	Output	Output port H$_0$ to H$_3$ (with high-voltage digit driver). Capable of 4-bit output and single-bit set/reset. Capable of 4-bit input of output latch contents and single-bit decision of output latch for branch. Use/nonuse of pull-down resistor bitwise selectable by option.
PI$_{0,1}$	Output	Output port I$_0$, I$_1$ (with high-voltage digit driver). Capable of 2-bit output and single-bit set/reset. Capable of 2-bit input of output latch contents and single-bit decision of output latch for branch. Use/nonuse of pull-down resistor bitwise selectable by option.
OSC1	Input	Pin for supplying external clock. If the internal clock mode is used, C, R or a ceramic resonator is connected to this pin and pin OSC2.
OSC2	Output	Pin for externally connecting a resonance circuit for the internal clock mode.
V$_{DD}$	Input	Power supply pin. Normally connected to +5V.
V$_{SS}$	—	Connected to 0V power supply.
V$_P$	Input	Power supply for high-voltage port pull-down resistor.
TEST	Input	LSI test pin. Normally connected to V$_{SS}$ (0V).

System Block Diagram
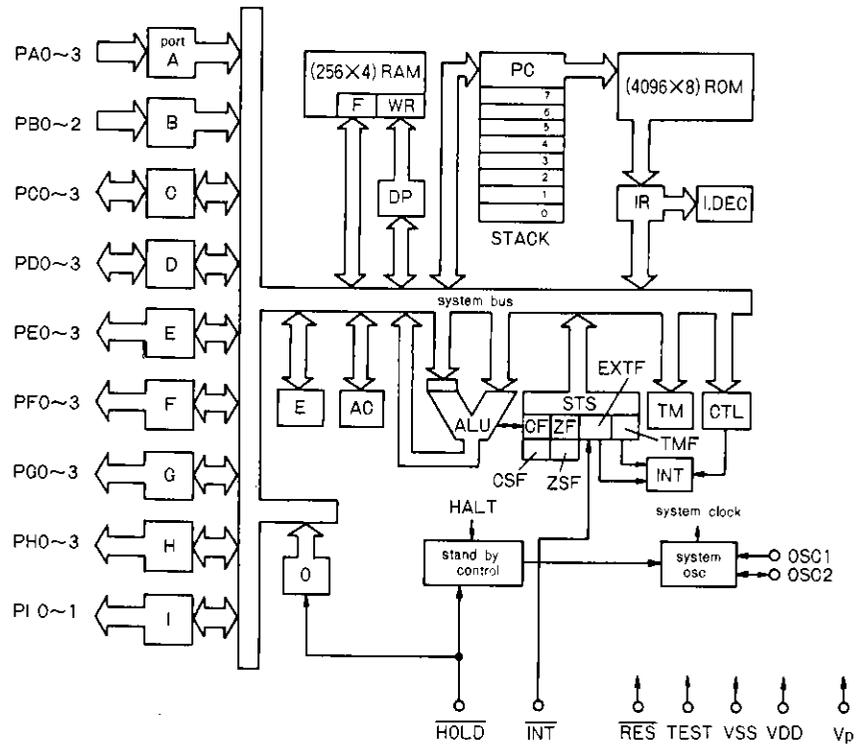
RAM:	Data memory	ROM:	Program memory
F:	Flag	PC:	Program counter
WR:	Working register	INT:	Interrupt control
AC:	Accumulator	IR:	Instruction register
ALU:	Arithmetic and logic unit	I.DEC:	Instruction decoder
DP:	Data pointer	CF, CSF:	Carry flag
E:	E register		Carry save flag
CTL:	Control register	ZF, ZSF:	Zero flag
OSC:	Oscillator		Zero save flag
TM:	Timer	EXTF:	External interrupt request flag
STS:	Status register	TMF:	Internal interrupt request flag

Absolute Maximum Ratings at Ta=25°C, V$_{SS}$=0V (V$_{DD}$=5V±20% unless otherwise specified)

				unit
Maximum Supply Voltage	V$_{DD}$ max		−0.3∼+7.0	V
Input Voltage	V$_{IN}$ (1)	Inputs other than Vp	−0.3∼V$_{DD}$+0.3	V (Note 1)
	V$_{IN}$ (2)	Vp	V$_{DD}$−45∼V$_{DD}$+0.3	V
Output Voltage	V$_{OUT}$ (1)	Outputs other than ports E, F, G, H, I	−0.3∼V$_{DD}$+0.3	V
	V$_{OUT}$ (2)	Ports E, F, G, H, I	V$_{DD}$−45∼V$_{DD}$+0.3	V
Peak Output Current	I$_O$ (1)	Each pin of ports C, D	−2.0∼+2.0	mA
	I$_O$ (2)	Each pin of ports E, F	−10∼0	mA
	I$_O$ (3)	Each pin of ports G, H, I	−15∼0	mA
	I$_O$ (4)	All pins of ports C to I	−90∼+16	mA
Allowable Power Dissipation	Pd max (1)	DIP package, Ta=−30 to +70°C	600	mW
	Pd max (2)	Flat package, Ta=−30 to +70°C	400	mW
Operating Temperature	Topr		−30∼+70	°C
Storage Temperature	Tstg		−55∼+125	°C

Note 1: For pin OSC1, up to oscillation amplitude generated when internally oscillated under the recommended oscillation conditions in Fig. 3 is allowable.

Recommended Operating Conditions at Ta=−30 to +70°C, V$_{SS}$=0V (V$_{DD}$=4.0 to 6.0V unless otherwise specified)

|			min	typ	max	unit
Operating Supply Voltage	V$_{DD}$		4.0	5.0	6.0	V
Power-down Supply Voltage	V$_{DD}$(MR)	$\overline{HOLD}$=V$_{IL}$(4), HOLD mode	1.8		6.0	V
"H"-Level Input Voltage	V$_{IH}$ (1)	Ports A to D, port A: "normal threshold input"	0.7V$_{DD}$		V$_{DD}$	V
	V$_{IH}$ (2)	V$_{DD}$=4.5 to 5.5V, port A: "low threshold input"	1.9		V$_{DD}$	V
	V$_{IH}$ (3)	$\overline{INT}$, $\overline{RES}$, $\overline{HOLD}$, OSC1 pins	0.8V$_{DD}$		V$_{DD}$	V
"L"-Level Input Voltage	V$_{IL}$ (1)	Ports A to D, port A: "normal threshold input"	V$_{SS}$		0.3V$_{DD}$	V
	V$_{IL}$ (2)	V$_{DD}$=4.5 to 5.5V, port A: "low threshold input"	V$_{SS}$		0.5	V
	V$_{IL}$ (3)	$\overline{INT}$, $\overline{RES}$, OSC1 pins	V$_{SS}$		0.2V$_{DD}$	V
	V$_{IL}$ (4)	V$_{DD}$=1.8 to 6.0V, $\overline{HOLD}$, TEST pins	V$_{SS}$		0.2V$_{DD}$	V
Operating Clock Frequency	fextosc	At external clock input, See Fig. 1.	222		1290	kHz
"H"-Level Clock Pulse Width	twϕH	〃	0.3			μs
"L"-Level Clock Pulse Width	twϕL	〃	0.3			μs
Clock Input Rise Time	toscR	〃			0.2	μs
Clock Input Fall Time	toscF	〃			0.2	μs
External Capacitance for CR OSC	Cext	} See Fig. 8			220±5 %	pF
External Resistance for CR OSC	Rext				6.8±1 %	kΩ
External Circuit Constants for Ceramic OSC	R1, R2 C1, C2	See Fig. 3				
Standby Timing	t$_{VDDR}$	See Fig. 6, V$_{DD}$=1.8 to 6.0V	0			μs
	t$_{VDDF}$	〃 〃	0			μs
Allowable Delay in Key Scan Circuit	t$_{DL}$	See Figs. 9, 10.			(N−3)·Tc	μs
	t$_{DH}$	〃			(N−3)·Tc	μs

LC6514B
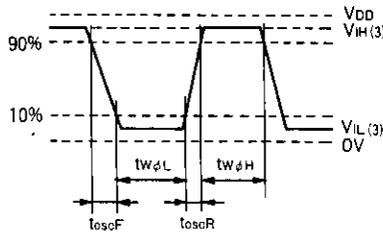
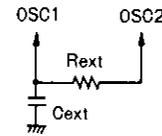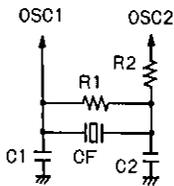Fig. 1 OSC1 Pin Input Waveform

Fig. 2 Recommended Oscillator for CR OSC

CF: Ceramic resonator

CSB400P (Murata)
KBR400B (Kyocera)
CSB800K (Murata)
KBR800H (Kyocera)
CSB1000K (Murata)

Fig. 3 Recommended Oscillator for Ceramic OSC

Center Frequency	CF	C1(pF)	C2(pF)	R1(kΩ)	R2(kΩ)
400kHz	CSB400P (Murata)	470	470	1000	1.5
	KBR400B (Kyocera)	470	470	1000	1.5
800kHz	CSB800K (Murata)	220	220	1000	1.0
	KBR800H (Kyocera)	220	220	1000	1.0
		150	150	1000	1.5
1000kHz	CSB1000K (Murata)	100	100	1000	1.5

C1, C2: Tolerance ±10%
R1, R2: Tolerance ±5%

Electrical Characteristics/Ta=−30 to +70°C, V_{DD}=5V ±20%, V_{SS}=0V

			min	typ	max	unit
"H"-Level Input Current	I_{IH}	All input pins except Vp, $V_{IN}=V_{DD}$			1	μA
"L"-Level Input Current	I_{IL}	All input pins except Vp, $V_{IN}=V_{SS}$	−1			μA
"H"-Level Output Voltage	$V_{OH(1)}$	Ports C, D: I_{OH}=−1mA	V_{DD}−2.0			V
	$V_{OH(2)}$	Ports C, D: I_{OH}=−100μA	V_{DD}−0.5			V
	$V_{OH(3)}$	Ports E, F: I_{OH}=−2mA	V_{DD}−1.0			V
	$V_{OH(4)}$	Ports E, F: I_{OH}=−1mA, all ports I_{OH}=−1mA	V_{DD}−0.5			V
	$V_{OH(5)}$	Ports G, H, I: I_{OH}=−10mA	V_{DD}−1.8			V
	$V_{OH(6)}$	Ports G, H, I: I_{OH}=−2mA	V_{DD}−1.0			V
	$V_{OH(7)}$	Ports G, H, I: I_{OH}=−1mA, all ports I_{OH}=−1mA	V_{DD}−0.5			V
"L"-Level Output Voltage	$V_{OL(1)}$	Ports C, D: I_{OL}=1mA			0.4	V
	$V_{OL(2)}$	Ports E, F, G, H, I: Vp=−35V, output Tr OFF, output open, with pull-down resistor			−33	V
"L"-Level Output Current (Output Pull-down resistor)	I_{OL} (R_{PD})	Ports E, F, G, H, I: Vp=−35V, V_{OL}=3V, V_{DD}=5V, with pull-down resistor	0.190 (200)	0.362 (105)	0.760 (50)	mA (kΩ)
Output OFF Leak Current	$I_{OFF(1)}$	Ports C, D: $V_{OUT}=V_{DD}$			1.0	μA
	$I_{OFF(2)}$	Ports C, D: $V_{OUT}=V_{SS}$	−1.0			μA
	$I_{OFF(3)}$	Port E to I: $V_{OUT}=V_{DD}$, OD output			30	μA
	$I_{OFF(4)}$	Port E to I: $V_{OUT}=V_{DD}$−40V, OD output	−30			μA
Clock OSC Frequency for Ceramic OSC	$f_{CFOSC(1)}$	Recommended conditions for ceramic OSC, at OSC circuit in Fig. 3 (Note 1)	384	400	416	kHz
	$f_{CFOSC(2)}$	"	768	800	832	kHz
	$f_{CFOSC(3)}$	"	960	1000	1040	kHz
Clock OSC Frequency for CR OSC	f_{CROSC}	Cext=220pF, Rext=6.8kΩ, at OSC circuit in Fig. 2	600	800	1220	kHz
Current Dissipation	$I_{DD(1)}$	At CR OSC, Cext=220pF, Rext=6.8kΩ, output pin open, input pin, $V_{IN}=V_{DD}$		1.0	2.0	mA
	$I_{DD(2)}$	At ceramic OSC (800kHz), output pin open, input pin, $V_{IN}=V_{DD}$		1.0	2.0	mA
	$I_{DD(3)}$	HALT mode, V_{DD}=4.0 to 6.0V, at test circuit in Fig. 4			10	μA
	$I_{DD(4)}$	HOLD mode, V_{DD}=1.8 to 6.0 V, at test circuit in Fig. 5			10	μA

(Note 1) f_{CFOSC}: Oscillatable frequency

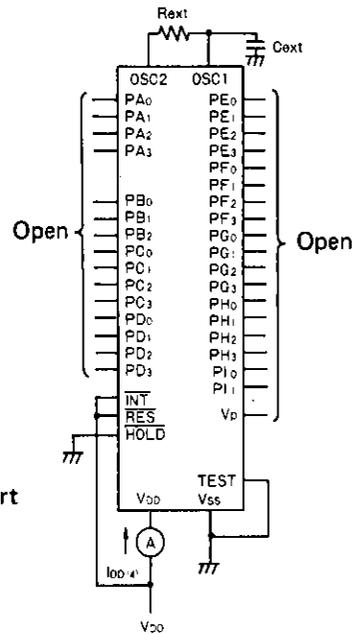| Continued from preceding page.			min	typ	max	unit
Input Capacitance	C_{IN}	f=1MHz		5		pF
Output Capacitance	C_{OUT}	f=1MHz, output: high impedance		10		pF
Input/Output Capacitance	C_{IO}	"		10		pF

Input/output common port
C, D: Output inhibit
The HALT instruction
is executed to cause the
HALT mode to be entered.
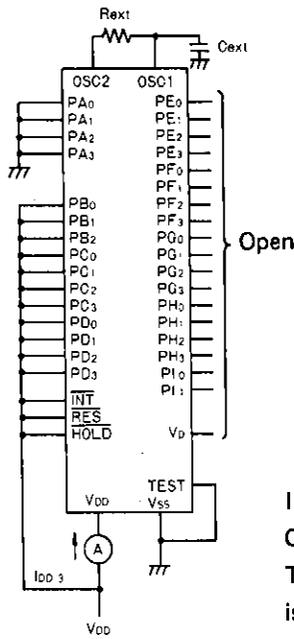
Fig. 4 $I_{DD(3)}$ Test Circuit

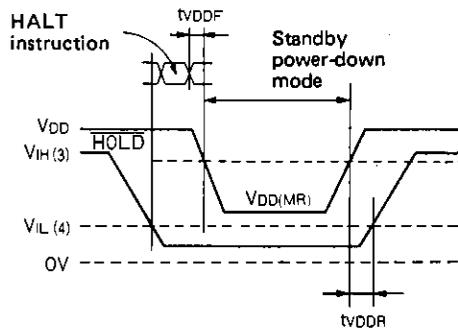Fig. 5 $I_{DD(4)}$ Test Circuit

Fig. 6 Standby Mode Timing

(Note)
During the HALT instruction
execution cycle, no chattering
must be applied to the $\overline{HOLD}$
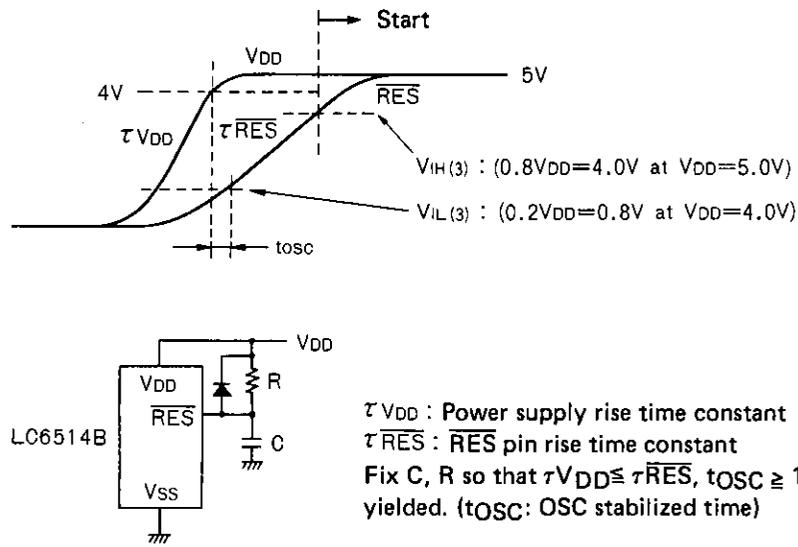pin and PA0 to 3 pins.

Fig. 7 Initial Reset Timing

τ Vdd : Power supply rise time constant
$\tau\overline{RES}$: $\overline{RES}$ pin rise time constant
Fix C, R so that $\tau V_{DD} \leqq \tau\overline{RES}$, $t_{OSC} \geqq$ 10msec is
yielded. (t_{OSC}: OSC stabilized time)

CR OSC characteristic of LC6514B

Fig. 8 shows the CR OSC characteristic of the LC6514B. For the variation range of CR OSC frequency of the LC6514B, the following is guaranteed at external constants of Cext=220pF, Rext=6.8kohm only. The outgoing inspection is performed under this condition only.

$$600kHz \leqq f_{CROSC} \leqq 1220kHz \qquad \left(\begin{array}{l} Ta=-30°C \sim +70°C \\ V_{DD}= 4 \sim 6 V \end{array} \right)$$

If any other constants than specified above are used, the range of Rext=5k to 50kohm, Cext=100p to 300pF must be observed. (See Fig. 8.)

Fig. 8 f$_{CROSC}$.- Rext
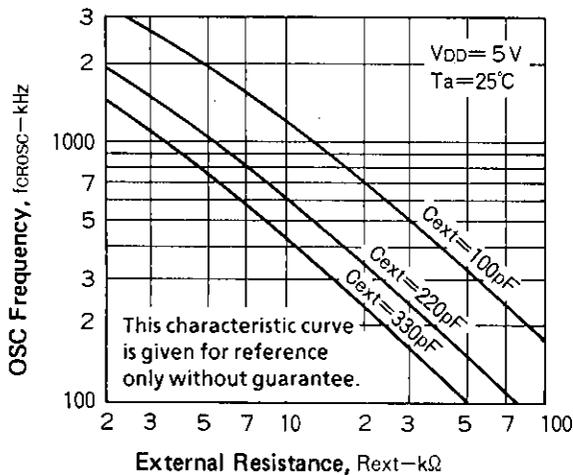
Note 1. The OSC frequency at V_{DD}=5V, Ta=25°C must be 800kHz or less.

Note 2. The OSC frequency at V_{DD}=4 to 6V, Ta= −30 to +70°C must be within the operation clock frequency range (222kHz to 1290 kHz).

Proper cares in using the IC

[Digit drive signal-used key scan]

When key-scanning with the FLT digit drive signal in Fig. 9 and inputting the return signal to port A, the following must be observed.

(a) Estimate voltage drop (V_{ON}) in the output transistor using the current flowing in an FLT used and the V-I characteristic of the output port of the LC6514B.

(b) Estimate voltage drop (V_{SW}) in the switch circuit.

(c) Check to see that $(V_{ON} + V_{SW})$ meets the V_{IH}/V_{IL} requirement of the input port.
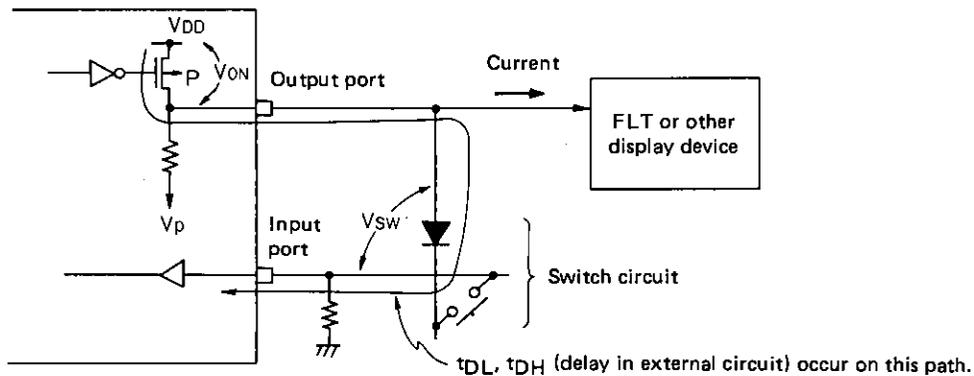
Fig. 9 Sample Key Scan Application

For the key scan application in Fig. 9, make the program considering the delay in the external circuit and the input delay shown below.
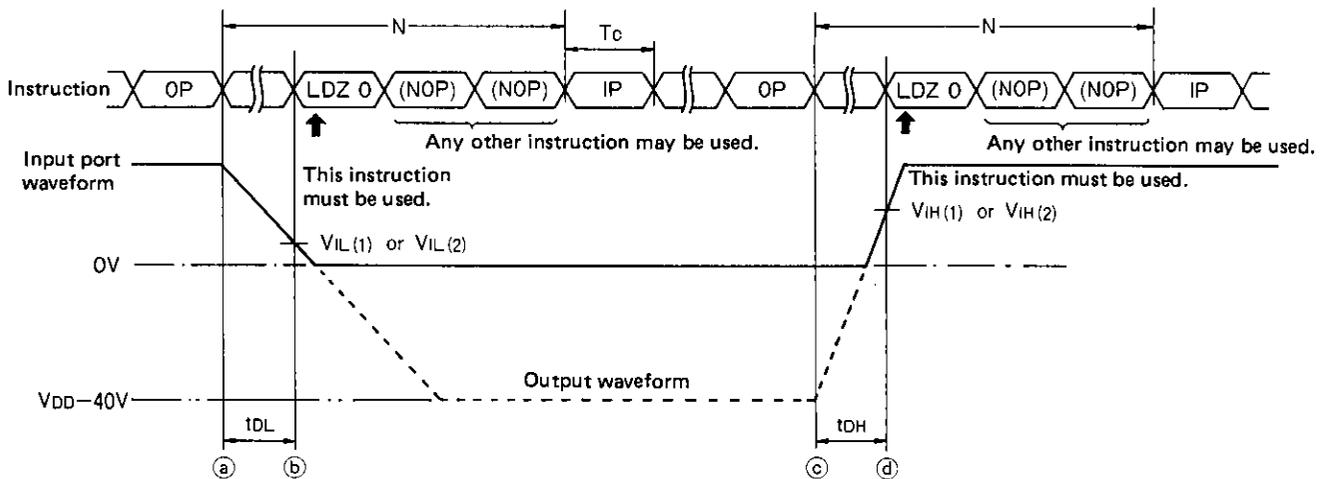
N: Number of instruction cycles existing between instruction (OP, SPB, RPB) used to output data to output port and instruction (IP, BP, BNP) used to input data from input port.
   (Number of instruction cycles to be programmed according to the length of t_{DL}, t_{DH})

t_{DL}, t_{DH}: Delay in external circuit from output port to input port .

When the IP instruction is used to input the return signal as shown in Fig. 10, the input delay must be considered and three instructions are placed between the IP instruction and the crossing of input port waveform and $V_{IL(1)}$ or $V_{IL(2)}$, $V_{IH(1)}$ or $V_{IH(2)}$ respectively.

Some instructions must be placed additionally according to the length of delay (t_{DL}, t_{DH}) in the external circuit after the digit drive signal is delivered with the execution of the OP instruction (ⓐ and ⓒ).

<Notes for Standby Function Application>

[Proper cares in using standby function]

The LC6514B provides the standby function called HALT, HOLD mode to minimize the current dissipation when the program is in the wait state. The standby function is controlled by the HALT instruction, the $\overline{\text{HOLD}}$ pin, $\overline{\text{RES}}$ pin. A peripheral circuit and program must be so designed as to provide precise control of the standby function. In most applications where the standby function is performed, voltage regulation, instantaneous break of power, and external noise are not negligible. When designing an application circuit and program, whether or not to take some measures must be considered according to the extent to which these factors are allowed.

This section mainly describes power failure backup for which the standby function is mostly used. A sample application circuit where the standby function is performed precisely is shown below and notes for circuit design and program design are also given below. When using the standby function, the application circuit shown below must be used and the notes must be also fully observed. If any other method than shown in this section is applied, it is necessary to fully check the environmental conditions such as power failure and the actual operation of an application equipment.

[Sample application and notes]

When using the HOLD mode, an application circuit and program must be designed with the following in mind.

(1) The supply voltage at the standby state must not be less than specified.
(2) Input timing of each control signal ($\overline{\text{HOLD}}$, $\overline{\text{RES}}$, port A, $\overline{\text{INT}}$, etc.) at the standby initiate/release state.
(3) Release operation must not be overlapped at the time of execution of the HALT instruction.

A sample application where the standby function is used for power failure backup is shown below as a concrete method to observe these notes. A sample application circuit, its operation, and notes for program design are given below.

1. Sample application where the standby function is used for power failure backup

   Power failure backup is an application where power failure of the main power source is detected by the $\overline{\text{HOLD}}$ pin, etc. to cause the HOLD mode to be entered so that the current dissipation is minimized and a backup capacitor is used to retain the contents of the internal registers even during power failure.

1-1. Sample application circuit (CF OSC)

   Fig. 11 shows a CF OSC-applied circit where the standby function is used for power failure backup.

Unit (resistance: Ω, capacitance: F)

Fig. 11 Sample Application Circuit

1-2. Operating waveform

The operating waveform in the sample application circuit in Fig. 11 is shown below. The mode is roughly divided as follows:

① Initial application of power
② Instantaneous break
③ Return from backup mode

① Initial application of power
② Instantaneous break-(2)
② Instantaneous break-(3)

③ Return from backup voltage

1-3. Operation of sample application circuit

① **At the time of initial application of power**
   A reset occurs and the execution of the program starts at address 000H of the program counter (PC).

② **At the time of instantaneous break**
   (1) At the time of very short instantaneous break
       The execution of the program continues.
   (2) At the time of instantaneous break being a little longer than (1)
       (When the $\overline{RES}$ input voltage meets V_{IL} and $\overline{HOLD}$ input voltage does not meet V_{IL})
       A reset occurs during the execution of the program and the execution of the program starts at address 000H of the program counter (PC).
       Since the HOLD request signal is not applied to the $\overline{HOLD}$ pin, the HOLD mode is not entered.
   (3) At the time of long instantaneous break (When both of the $\overline{RES}$ input voltage and $\overline{HOLD}$ input voltage meet V_{IL})
       The HOLD request signal is applied to the $\overline{HOLD}$ pin and the HOLD mode is entered.
       When V+ rises after instantaneous break, a reset occurs to release the HOLD mode and the execution of the program starts at address 000H of the program counter (PC).

③ **At the time of return from backup voltage**
   A reset occurs and the execution of the program starts at address 000H of the program counter (PC).

1-4. Notes for circuit design

① How to fix C3, R6, C2, R2

Fix closed loop Ⓐ discharge time constants C3, R6 and $\overline{HOLD}$ pin charge time constants C2, R2 so that closed loop Ⓐ fully discharges before the $\overline{HOLD}$ input voltage gets lower than V_{IL} at the time of instantaneous break and the $\overline{RES}$ input voltage is sure to get lower than V_{IL} (a reset occurs) when V+ rises after instantaneous break where the $\overline{HOLD}$ input voltage gets lower than V_{IL}.

② How to fix C3, R7

Fix $\overline{RES}$ pin charge time constants C3, R7 so that when power is applied initially or the HOLD mode is released the CF OSC oscillates normally and the $\overline{RES}$ input voltage exceeds V_{IH} and the program starts running.

③ How to fix R4, R5

Fix Tr bias constants R4, R5 so that when V+ rises after instantaneous break the $\overline{RES}$ input voltage gets lower than V_{IL} (brought to "L" level) before the $\overline{HOLD}$ input voltage exceeds V_{IH} (brought to "H" level).

④ How to fix C2, R3

Fix $\overline{HOLD}$ pin charge time constants C2, R3 so that when the HOLD mode is released from the backup mode the $\overline{HOLD}$ input voltage does not exceed V_{IH} (not brought to "H" level) until the $\overline{RES}$ input voltage gets lower than V_{IL} (brought to "L" level).

Fix C3, R7 and C2, R3 so that the time interval from the moment the $\overline{HOLD}$ input voltage exceeds V_{IH} until the $\overline{RES}$ input voltage exceeds V_{IH} is longer than the CF OSC stabilizing time.

⑤ When the load is heavy or the polling interval is long

Since C1 discharges largely, increase the capacity of C1 or separate Ⓑ detection from V+ and use a power supply or signal that rises faster than V+.

1-5. Notes for software design

When the HOLD request signal is detected, the HALT instruction is executed immediately. A concrete example is shown below.

① An interrupt is inhibited before polling the HOLD request pin ($\overline{HOLD}$ pin).

② Polling of the $\overline{HOLD}$ pin and the HALT instruction are programmed consecutively.

[Concrete example]

```
        RCTL        3        ; EXTEN, TMEN ← 0 (External, timer interrupt inhibit)
        BP0         AAA      ; Polling of the HOLD pin (If "H" level, a branch occurs to AAA.)
        HALT                 ; The HOLD mode is entered.
AAA:
```

Application development tools

Evaluation chip (LC6597), simulation chip (LC65PG97) and the dedicated equipment called "application development tools" are available to facilitate application development of the LC6514B.

● SDS-410 system

This is a combination of floppy disk-provided CPU, CRT, and printer. This system enables application development programs of microcomputers to be prepared (edited, assembled) very speedily and efficiently in assembly language. By connecting the EVA-410 to the CPU, programs can be debugged and assembled data can be written into the EPROM (using EPROM WRITER function contained in the EVA-410).

● EVA-410

This is an evaluation kit having EPROM WRITER function, function of parallel/serial data communication with external equipment (SDS-410, etc.). This kit enables application development programs to be corrected or debugged on the machine language level.

● EVA-TB3B

This is a board which is connected with the EVA-410 to develop programs dedicated to the LC6514B.

● EVA-97-14B

Simulation chip (LC65PG97) is identical with the LC6510C in the I/O port breakdown voltage and pin assignment. Since the LC6514B has high-voltage output ports and differs partially in the pin assignment, conversion board "EVA-97-14B" with high-voltage drivers is used to evaluate the LC6514B.

(Note) The threshold level of input port A of the LC6514B can be selected to be normal/low level by option. However, since port A of the EVA-TB3B, EVA-97-14B is of normal threshold input type, they cannot be used to evaluate the low threshold input version of the LC6514B.
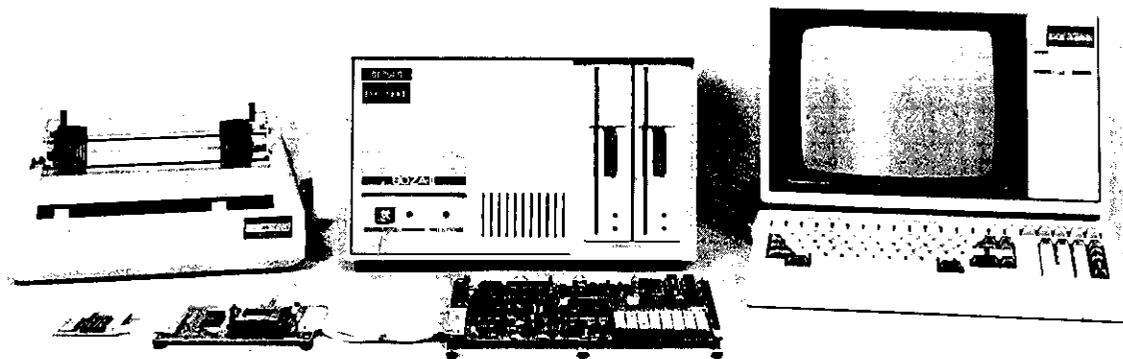
APPENDIX   LC6510 Series Instruction Set (by Function)

Symbols	Meaning
AC:	Accumulator
ACt:	Accumulator bit t
CF:	Carry flag
CTL:	Control register
DP:	Data pointer
E:	E register
EXTF:	External interrupt request flag
Fn:	Flag bit n

M:	Memory
M(DP):	Memory addressed by DP
P(DPL):	Input/output port addressed by DPL
PC:	Program counter
STACK:	Stack register
TM:	Timer
TMF:	Timer (internal) interrupt request flag
At, Ha, La:	Working register
ZF:	Zero flag

( ), [ ]:	Contents
←:	Transfer and direction
+:	Addition
−:	Subtraction
Λ:	AND
V:	OR
∀:	Exclusive OR

Instruction	Mnemonic		Instruction code $D_7D_6D_5D_4$	$D_3D_2D_1D_0$	Bytes	Cycles	Function	Description	Status flag affected	Remarks
Accumulator manipulation instructions	CLA	Clear AC	1 1 0 0	0 0 0 0	1	1	$AC \leftarrow 0$	The AC contents are cleared.	ZF	*1
	CLC	Clear CF	1 1 1 0	0 0 0 1	1	1	$CF \leftarrow 0$	The CF is reset.	CF	
	STC	Set CF	1 1 1 1	0 0 0 1	1	1	$CF \leftarrow 1$	The CF is set.	CF	
	CMA	Complement AC	1 1 1 0	1 0 1 1	1	1	$AC \leftarrow \overline{(AC)}$	The AC contents are complemented (zero bits become 1, one bits become 0).	ZF	
	INC	Increment AC	0 0 0 0	1 1 1 0	1	1	$AC \leftarrow (AC)+1$	The AC contents are incremented +1.	ZF CF	
	DEC	Decrement AC	0 0 0 0	1 1 1 1	1	1	$AC \leftarrow (AC)-1$	The AC contents are decremented −1.	ZF CF	
	RAL	Rotate AC left through CF	0 0 0 0	0 0 0 1	1	1	$AC_0 \leftarrow (CF), AC_{n+1} \leftarrow (AC_n), CF \leftarrow (AC_3)$	The AC contents are shifted left through the CF.	ZF CF	
	TAE	Transfer AC to E	0 0 0 0	0 0 1 1	1	1	$E \leftarrow (AC)$	The AC contents are transferred to the E.		
	XAE	Exchange AC with E	0 0 0 0	1 1 0 1	1	1	$(AC) \leftrightarrows (E)$	The AC contents and the E contents are exchanged.		
Memory manipulation instructions	INM	Increment M	0 0 1 0	1 1 1 0	1	1	$M(DP) \leftarrow (M(DP))+1$	The M(DP) contents are incremented +1.	ZF CF	
	DEM	Decrement M	0 0 1 0	1 1 1 1	1	1	$M(DP) \leftarrow (M(DP))-1$	The M(DP) contents are decremented −1.	ZF CF	
	SMB bit	Set M data bit	0 0 0 0	1 0 B_1B_0	1	1	$M(DP, B_1B_0) \leftarrow 1$	A single bit of the M(DP) specified by B_1B_0 is set.		
	RMB bit	Reset M data bit	0 0 1 0	1 0 B_1B_0	1	1	$M(DP, B_1B_0) \leftarrow 0$	A single bit of the M(DP) specified by B_1B_0 is set.	ZF	
Operation/comparison instructions	AD	Add M to AC	0 1 1 0	0 0 0 0	1	1	$AC \leftarrow (AC)+(M(DP))$	The AC contents and the M(DP) contents are binary-added and the result is placed in the AC.	ZF CF	
	ADC	Add M to AC with CF	0 0 1 0	0 0 0 0	1	1	$AC \leftarrow (AC)+(M(DP))+(CF)$	The AC, CF, M(DP) contents are binary-added and the result is placed in the AC.	ZF CF	
	DAA	Decimal adjust AC in addition	1 1 1 0	0 1 1 0	1	1	$AC \leftarrow (AC)+6$	6 is added to the AC contents.	ZF	
	DAS	Decimal adjust AC in subtraction	1 1 1 0	1 0 1 0	1	1	$AC \leftarrow (AC)+10$	10 is added to the AC contents.	ZF	
	EXL	Exclusive or M to AC	1 1 1 1	0 1 0 1	1	1	$AC \leftarrow (AC) \forall (M(DP))$	The AC contents and the M(DP) contents are exclusive-ORed and the result is placed in the AC.	ZF	
	AND	And M to AC	1 1 1 0	0 1 1 1	1	1	$AC \leftarrow (AC) \wedge (M(DP))$	The AC contents and the M(DP) contents are ANDed and the result is placed in the AC.	ZF	
	OR	Or M to AC	1 1 1 0	0 1 0 1	1	1	$AC \leftarrow (AC) \vee (M(DP))$	The AC contents and the M(DP) contents are ORed and the result is placed in the AC.	ZF	
	CM	Compare AC with M	1 1 1 1	1 0 1 1	1	1	$\overline{(M(DP))}+(AC)+1$	The AC contents and the M(DP) contents are compared and the CF and ZF are set/reset.	ZF CF	
	CI data	Compare AC with immediate data	0 0 1 0 / 0 1 0 0	1 1 0 0 / $I_3I_2I_1I_0$	2	2	$\overline{I_3I_2I_1I_0}+(AC)+1$	The AC contents and immediate data $I_3I_2I_1I_0$ are compared and the ZF and CF are set/reset.	ZF CF	
	CLI data	Compare DPL with immediate data	0 0 1 0 / 0 1 0 1	1 1 0 0 / $I_3I_2I_1I_0$	2	2	$(DP_L) \forall I_3I_2I_1I_0$	The DPL contents and immediate data $I_3I_2I_1I_0$ are compared.	ZF	
	LI data	Load AC with immediate data	1 1 0 0	$I_3I_2I_1I_0$	1	1	$AC \leftarrow I_3I_2I_1I_0$	Immediate data $I_3I_2I_1I_0$ is loaded in the AC.	ZF	*1
Load/store instructions	S	Store AC to M	0 0 0 0	0 0 1 0	1	1	$M(DP) \leftarrow (AC)$	The AC contents are stored in the M(DP).		
	L	Load AC from M	0 0 1 0	0 0 0 1	1	1	$AC \leftarrow (M(DP))$	The M(DP) contents are loaded in the AC.	ZF	
	XM data	Exchange AC with M, then modify DPH with immediate data	1 0 1 0	0 $M_2M_1M_0$	1	2	$(AC) \leftrightarrows (M(DP))$ $DP_H \leftarrow (DP_H) \forall 0 M_2M_1M_0$	The AC contents and the M(DP) contents are exchanged. Then, the DPH contents are modified with the contents of (DPH) $\forall 0M_2M_1M_0$.	ZF	The ZF is set/reset according to the result of $(DP_H) \forall 0M_2M_1M_0$.
	X	Exchange AC with M	1 0 1 0	0 0 0 0	1	2	$(AC) \leftrightarrows (M(DP))$	The AC contents and the M(DP) contents are exchanged.	ZF	The ZF is set/reset according to the DPH contents at the time of instruction execution.
	XI	Exchange AC with M, then increment DPL	1 1 1 1	1 1 1 0	1	2	$(AC) \leftrightarrows (M(DP))$ $DP_L \leftarrow (DP_L)+1$	The AC contents and the M(DP) contents are exchanged. Then, the DPL contents are incremented +1.	ZF	The ZF is set/reset according to the result of (DP_L+1).
	XD	Exchange AC with M, then decrement DPL	1 1 1 1	1 1 1 1	1	2	$(AC) \leftrightarrows (M(DP))$ $DP_L \leftarrow (DP_L)-1$	The AC contents and the M(DP) contents are exchanged. Then, the DPL contents are decremented −1.	ZF	The ZF is set/reset according to the result of (DP_L-1).
	RTBL	Read table data from program ROM	0 1 1 0	0 0 1 1	1	2	$AC, E \leftarrow ROM$ (PCh, E, AC)	The contents of ROM addressed by the PC whose low-order 8 bits are replaced with the E and AC contents are loaded in the AC and E.		

CM comparison result:

Comparison result	CF	ZF
$(M(DP)) > (AC)$	0	0
$(M(DP)) = (AC)$	1	1
$(M(DP)) < (AC)$	1	0

CI data comparison result:

Comparison result	CF	ZF
$I_3I_2I_1I_0 > (AC)$	0	0
$I_3I_2I_1I_0 = (AC)$	1	1
$I_3I_2I_1I_0 < (AC)$	1	0

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Instruction	Mnemonic		Instruction code D7 D6 D5 D4	Instruction code D3 D2 D1 D0	Bytes	Cycles	Function	Description	Status flag affected	Remarks
Data pointer manipulation instructions	LDZ data	Load DPH with Zero and DPL with immediate data respectively	1 0 0 0	I3 I2 I1 I0	1	1	DPH ←0 DPL ←I3 I2 I1 I0	The DPH and DPL are loaded with 0 and immediate data I3I2I1I0 respectively.		
	LHI data	Load DPH with immediate data	0 1 0 0	I3 I2 I1 I0	1	1	DPH ← I3 I2 I1 I0	The DPH is loaded with immediate data I3I2I1I0.		
	IND	Increment DPL	1 1 1 0	1 1 1 0	1	1	DPL ←(DPL)+1	The DPL contents are incremented +1.	ZF	
	DED	Decrement DPL	1 1 1 0	1 1 1 1	1	1	DPL ←(DPL)−1	The DPL contents are decremented −1.	ZF	
	TAL	Transfer AC to DPL	1 1 1 1	0 1 1 1	1	1	DPL ←(AC)	The AC contents are transferred to the DPL.		
	TLA	Transfer DPL to AC	1 1 1 0	1 0 0 1	1	1	AC ←(DPL)	The DPL contents are transferred to the AC.	ZF	
	XAH	Exchange AC with DPH	0 0 1 0	0 0 1 1	1	1	(AC) ⇄ (DPH)	The AC contents and the DPH contents are exchanged.		
Working register manipulation instructions	XAt XA0 XA1 XA2 XA3	Exchange AC with working register At	1 1 1 0 1 1 1 0 1 1 1 0 1 1 1 0	t1 t0 0 0 0 0 0 1 0 0 1 0 0 0 1 1 0 0	1 1 1 1	1 1 1 1	(AC) ⇄ (A0) (AC) ⇄ (A1) (AC) ⇄ (A2) (AC) ⇄ (A3)	The AC contents and the contents of working register A0, A1, A2, or A3 specified by t1t0 are exchanged.		
	XHa XH0 XH1	Exchange DPH with working register Ha	1 1 1 1 1 1 1 1	a 1 0 0 0 1 1 0 0	1 1	1 1	(DPH) ⇄ (H0) (DPH) ⇄ (H1)	The DPH contents and the contents of working register H0 or H1 specified by a are exchanged.		
	XLa XL0 XL1	Exchange DPL with working register La	1 1 1 1 1 1 1 1	a 0 0 0 0 0 1 0 0	1 1	1 1	(DPL) ⇄ (L0) (DPL) ⇄ (L1)	The DPL contents and the contents of working register L0 or L1 specified by a are exchanged.		
Flag manipulation instructions	SFB flag	Set flag bit	0 1 0 1	B3 B2 B1 B0	1	1	Fn ←1	A flag specified by B3B2B1B0 is set.		
	RFB flag	Reset flag bit	0 0 0 1	B3 B2 B1 B0	1	1	Fn ←0	A flag specified by B3B2B1B0 is reset.	ZF	The flags are divided into 4 groups of F0 to F3, F4 to F7, F8 to F11, F12 to F15. The ZF is set/reset according to the 4 bits including a single bit specified by immediate data B3B2B1B0.
Jump/subroutine instructions	JMP addr	Jump in the current bank	0 1 1 0 P7 P6 P5 P4	1 P10P9P8 P3 P2 P1 P0	2	2	PC ←PC11(or $\overline{PC11}$) P10P9P8P7P6P5 P4P3P2P1P0	A jump to an address specified by the PC11 (or $\overline{PC11}$) and immediate data P10 to P0 occurs.		If the BANK and JMP instructions are executed consecutively, $\overline{PC11}$ →PC11.
	JPEA	Jump in the current page modified by E and AC	1 1 1 1	1 0 1 0	1	1	PC7~0 ←(E,AC)	A jump to an address specified by the contents of the PC whose low-order 8 bits are replaced with the E and AC contents occurs.		
	CZP addr	Call subroutine in the zero page	1 0 1 1	P3 P2 P1 P0	1	1	STACK ←(PC)+1 PC11~6, PC1~0 ←0 PC5~2 ←P3 P2 P1 P0	A subroutine in page 0 of bank 0 is called.		
	CAL addr	Call subroutine in the zero bank	1 0 1 0 P7 P6 P5 P4	1 P10P9P8 P3 P2 P1 P0	2	2	STACK ←(PC)+2 PC11~0 ←0P10P9P8P7 P6P5P4P3P2P1P0	A subroutine in bank 0 is called.		
	RT	Return from subroutine	0 1 1 0	0 0 1 0	1	1	PC ←(STACK)	A return from a subroutine occurs.		
	RTI	Return from interrupt routine	0 0 1 0	0 0 1 0	1	1	PC ←(STACK) CF ZF ←CSF,ZSF	A return from an interrupt servicing routine occurs.	ZF CF	
	BANK	Change bank	1 1 1 1	1 1 0 1	1	1	PC11 ←($\overline{PC11}$)	The bank is changed.		Effective only when used immediately before the JMP instruction.
Branch instructions	BAt addr	Branch on AC bit	0 1 1 1 P7 P6 P5 P4	0 0 t1 t0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6P5 P4 P3 P2P1P0 if ACt = 1	If a single bit of the AC specified by immediate data t1t0 is 1, a branch to an address specified by immediate data P7 to P0 within the current page occurs.		Mnemonic is BA0 to BA3 according to the value of t.
	BNAt addr	Branch on no AC bit	0 0 1 1 P7 P6 P5 P4	0 0 t1 t0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6P5P4 P3 P2 P1 P0 if ACt = 0	If a single bit of the AC specified by immediate data t1t0 is 0 a branch to an address specified by immediate data P7 to P0 within the current page occurs.		Mnemonic is BNA0 to BNA3 according to the value of t.
	BMt addr	Branch on M bit	0 1 1 1 P7 P6 P5 P4	0 1 t1 t0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6 P5 P4 P3 P2 P1 P0 if (M(DP,t1 t0)) = 1	If a single bit of the M(DP) specified by immediate data t1t0 is 1, a branch to an address specified by immediate data P7 to P0 within the current page occurs.		Mnemonic is BM0 to BM3 according to the value of t.
	BNMt addr	Branch on no M bit	0 0 1 1 P7 P6 P5 P4	0 1 t1 t0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6 P5 P4 P3 P2 P1 P0 if (M(DP,t1 t0)) = 0	If a single bit of the M(DP) specified by immediate data t1t0 is 0, a branch to an address specified by immediate data P7 to P0 within the current page occurs.		Mnemonic is BNM0 to BNM3 according to the value of t.
	BPt addr	Branch on Port bit	0 1 1 1 P7 P6 P5 P4	1 0 t1 t0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6 P5 P4 P3 P2 P1 P0 if (P(DPL,t1 t0)) = 1	If a single bit of port P(DPL) specified by immediate data t1t0 is 1, a branch to an address specified by immediate data P7 to P0 within the current page occurs.		Mnemonic is BP0 to BP3 according to the value of t.
	BNPt addr	Branch on no Port bit	0 0 1 1 P7 P6 P5 P4	1 0 t1 t0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6 P5 P4 P3 P2 P1 P0 if (P(DPL,t1 t0)) = 0	If a single bit of port P(DPL) specified by immediate data t1t0 is 0, a branch to an address specified by immediate data P7 to P0 within the current page occurs.		Mnemonic is BNP0 to BNP3 according to the value of t.
	BTM addr	Branch on timer	0 1 1 1 P7 P6 P5 P4	1 1 0 0 P3 P2 P1 P0	2	2	PC7~0 ← P7 P6 P5 P4 P3 P2 P1 P0 if TMF = 1 then TMF ←0	If the TMF is 1, a branch to an address specified by immediate data P7 to P0 within the current page occurs. The TMF is reset.	TMF	

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Instruction	Mnemonic		Instruction code $D_7 D_6 D_5 D_4$	$D_3 D_2 D_1 D_0$	Bytes	Cycles	Function	Description	Status flag affected	Remarks
Branch instructions	BNTM addr	Branch on no timer	0 0 1 1 / $P_7 P_6 P_5 P_4$	1 1 0 0 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if TMF = 0 then TMF ← 0	If the TMF is 0, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs. The TMF is reset.	TMF	
	BI addr	Branch on interrupt	0 1 1 1 / $P_7 P_6 P_5 P_4$	1 1 0 1 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if EXTF = 1 then EXTF ← 0	If the EXTF is 1, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs. The EXTF is reset.	EXTF	
	BNI addr	Branch on no interrupt	0 0 1 1 / $P_7 P_6 P_5 P_4$	1 1 0 1 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if EXTF = 0 then EXTF ← 0	If the EXTF is 0, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs. The EXTF is reset.	EXTF	
	BC addr	Branch on CF	0 1 1 1 / $P_7 P_6 P_5 P_4$	1 1 1 1 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if CF = 1	If the CF is 1, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs.		
	BNC addr	Branch on no CF	0 0 1 1 / $P_7 P_6 P_5 P_4$	1 1 1 1 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if CF = 0	If the CF is 0, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs.		
	BZ addr	Branch on ZF	0 1 1 1 / $P_7 P_6 P_5 P_4$	1 1 1 0 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \sim P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if ZF = 1	If the ZF is 1, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs.		
	BNZ addr	Branch on no ZF	0 0 1 1 / $P_7 P_6 P_5 P_4$	1 1 1 0 / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if ZF = 0	If the ZF is 0, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs.		
	BFn addr	Branch on flag bit	1 1 0 1 / $P_7 P_6 P_5 P_4$	$n_3 n_2 n_1 n_0$ / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if Fn = 1	If a flag bit of the 16 flags specified by immediate data $n_3 n_2 n_1 n_0$ is 1, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs.		Mnemonic is BF0 to BF15 according to the value of n.
	BNFn addr	Branch on no flag bit	1 0 0 1 / $P_7 P_6 P_5 P_4$	$n_3 n_2 n_1 n_0$ / $P_3 P_2 P_1 P_0$	2	2	$PC_{7\sim0} \leftarrow P_7 P_6 P_5 P_4$ $P_3 P_2 P_1 P_0$ if Fn = 0	If a flag bit of the 16 flags specified by immediate data $n_3 n_2 n_1 n_0$ is 0, a branch to an address specified by immediate data P_7 to P_0 within the current page occurs.		Mnemonic is BNF0 to BNF15 according to the value of n.
Input/output instructions	IP	Input port to AC	0 0 0 0	1 1 0 0	1	1	AC ← (P(DPL))	The contents of port P(DPL) are inputted to the AC.	ZF	
	OP	Output AC to port	0 1 1 0	0 0 0 1	1	1	P(DPL) ← (AC)	The AC contents are outputted to port P(DPL).		
	SPB bit	Set port bit	0 0 0 0	0 1 $B_1 B_0$	1	2	P(DPL $B_1 B_0$) ← 1	Immediate data $B_1 B_0$-specified one bit in port P(DPL) is set.		Mnemonic is BNF0 to BNF15 according to the value of n.
	RPB bit	Reset port bit	0 0 1 0	0 1 $B_1 B_0$	1	2	P(DPL, $B_1 B_0$) ← 0	Immediate data $B_1 B_0$-specified one bit in port P(DPL) is reset.	ZF	When this instruction is executed, the E register contents are destroyed.
Other instructions	SCTL bit	Set control register bit (S)	0 0 1 0 / 1 0 0 0	1 1 0 0 / $B_3 B_2 B_1 B_0$	2	2	CTL ← (CTL) V $B_3 B_2 B_1 B_0$	Immediate data $B_3 B_2 B_1 B_0$-specified bits in the control register are set.		
	RCTL bit	Reset control register bit (S)	0 0 1 0 / 1 0 0 1	1 1 0 0 / $B_3 B_2 B_1 B_0$	2	2	CTL ← (CTL) ∧ $\overline{B_3 B_2 B_1 B_0}$	Immediate data $B_3 B_2 B_1 B_0$-specified bits in the control register are reset.	ZF	
	WTTM	Write timer	1 1 1 1	1 0 0 1	1	1	TM ← (E), (AC) TMF ← 0	The E and AC contents are loaded in the timer. The TMF is reset.	TMF	
	HALT	Halt	1 1 1 1	0 1 1 0	1	1	Halt	The standby mode is entered.		
	NOP	No operation	0 0 0 0	0 0 0 0	1	1	No operation	No operation is performed, but 1 machine cycle is consumed.		

*1 If the LI instruction or CLA instruction is used consecutively in such a manner as LI, LI, LI, ------, or CLA, CLA, CLA, ------, the first LI instruction or CLA instruction only is effective and the following LI instructions or CLA instructions are changed to the NOP instructions.